



# SPN4900

## N-Channel Enhancement Mode MOSFET

### DESCRIPTION

The SPN4900 is the Dual N-Channel logic enhancement mode power field effect transistors are produced using high cell density , DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application , notebook computer power management and other battery powered circuits where high-side switching .

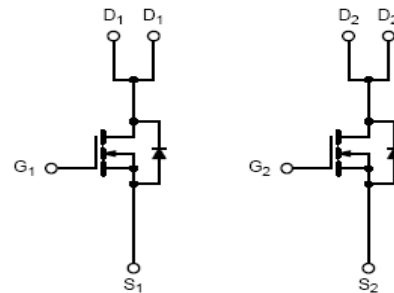
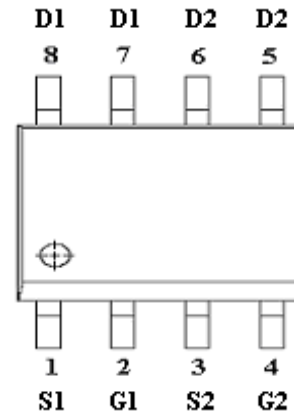
### FEATURES

- ◆ 60V/5.3A, $R_{DS(ON)}=118m\Omega@V_{GS}=10V$
- ◆ 60V/4.7A, $R_{DS(ON)}=125m\Omega@V_{GS}=4.5V$
- ◆ Super high density cell design for extremely low  $R_{DS(ON)}$
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ SOP-8 package design

### APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

### PIN CONFIGURATION(SOP-8)



### PART MARKING



A : Lot Code  
B : Date Code



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### PIN DESCRIPTION

Pin	Symbol	Description
1	S1	Source 1
2	G1	Gate 1
3	S2	Source 2
4	G2	Gate 2
5	D2	Drain 2
6	D2	Drain 2
7	D1	Drain 1
8	D1	Drain 1

### ORDERING INFORMATION

Part Number	Package	Part Marking
SPN4900S8RGB	SOP-8	SPN4900

※ SPN4546S8RGB 13" Tape Reel ; Pb – Free ; Halogen – Free

### ABSOLUTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit	
Drain-Source Voltage	V <sub>DSS</sub>	60	V	
Gate –Source Voltage	V <sub>GSS</sub>	±20	V	
Continuous Drain Current(T <sub>J</sub> =150°C)	I <sub>D</sub>	T <sub>A</sub> =25°C	4.2	A
		T <sub>A</sub> =70°C	3.2	
Pulsed Drain Current	I <sub>DM</sub>	20	A	
Avalanche Current	I <sub>AS</sub>	11	A	
Power Dissipation	P <sub>D</sub>	T <sub>A</sub> =25°C	2.5	W
		T <sub>A</sub> =70°C	1.6	
Operating Junction Temperature	T <sub>J</sub>	-55/150	°C	
Storage Temperature Range	T <sub>STG</sub>	-55/150	°C	
Thermal Resistance-Junction to Ambient	R <sub>θJA</sub>	80	°C/W	



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### ELECTRICAL CHARACTERISTICS

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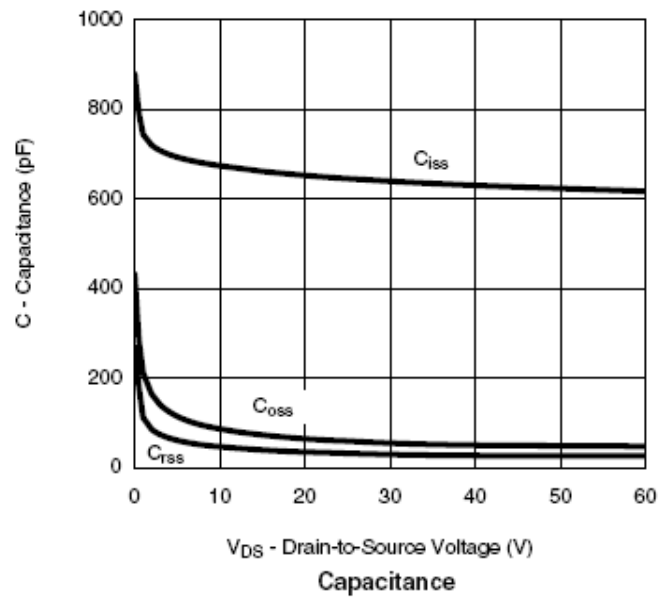
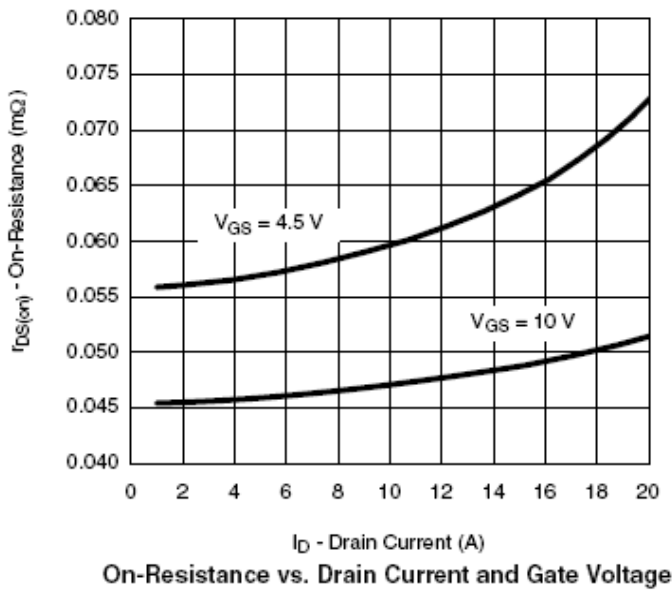
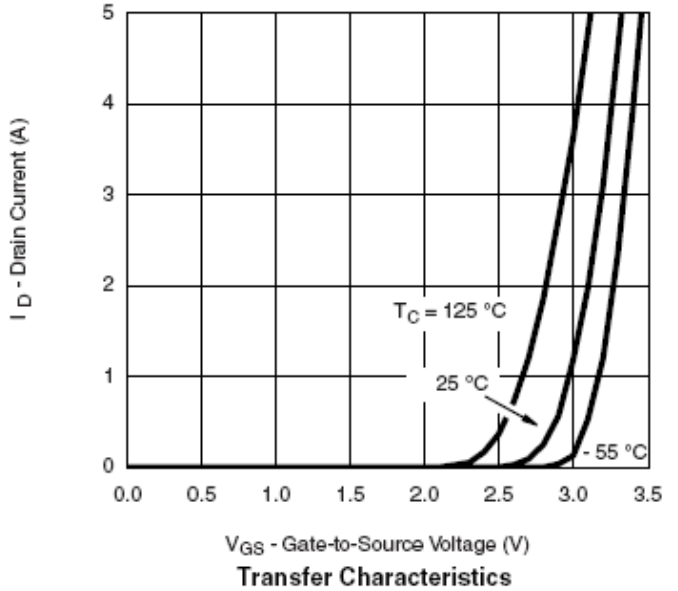
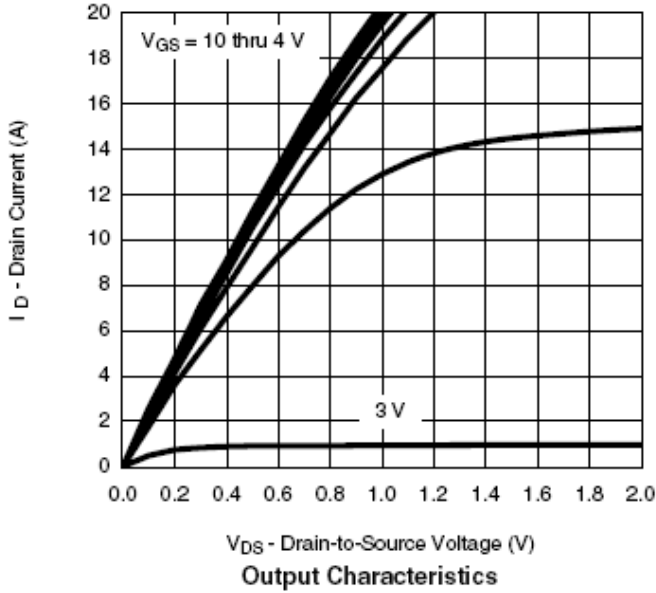
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	60			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	0.5		1.5	V
Gate Leakage Current	$I_{GSS}$	$V_{DS}=0V, V_{GS}=\pm 20V$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=60V, V_{GS}=0V$			1	uA
		$V_{DS}=60V, V_{GS}=0V$ $T_J=85^\circ C$			5	
On-State Drain Current	$I_{D(on)}$	$V_{DS}\geq 5V, V_{GS}=10V$	25			A
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=5.3A$		0.110	0.118	$\Omega$
		$V_{GS}=4.5V, I_D=4.7A$		0.115	0.125	
Forward Transconductance	$g_{fs}$	$V_{DS}=15V, I_D=4.3A$		15		S
Diode Forward Voltage	$V_{SD}$	$I_S=1.7A, V_{GS}=0V$		0.8	1.2	V
<b>Dynamic</b>						
Total Gate Charge	$Q_g$	$V_{DS}=30V, V_{GS}=10V$ $I_D=4.3A$		15	20	nC
Gate-Source Charge	$Q_{gs}$			2.5		
Gate-Drain Charge	$Q_{gd}$			2.6		
Input Capacitance	$C_{iss}$	$V_{DS}=15V, V_{GS}=0V$ $f=1MHz$		675		pF
Output Capacitance	$C_{oss}$			80		
Reverse Transfer Capacitance	$C_{rss}$			40		
Turn-On Time	$t_{d(on)}$	$V_{DD}=30V, R_L=8.8\Omega$ $I_D=3.4A, V_{GEN}=10V$ $R_G=1\Omega$		10	20	nS
	$t_r$			15	25	
Turn-Off Time	$t_{d(off)}$			25	35	
	$t_f$			12	20	



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### TYPICAL CHARACTERISTICS

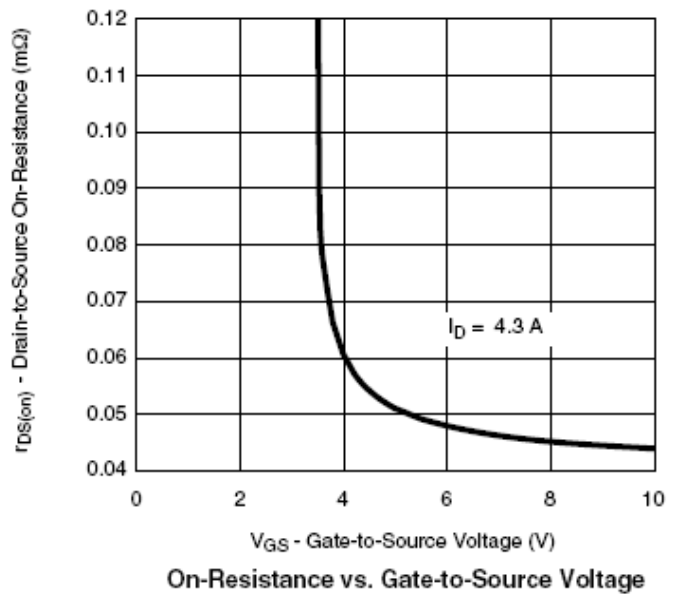
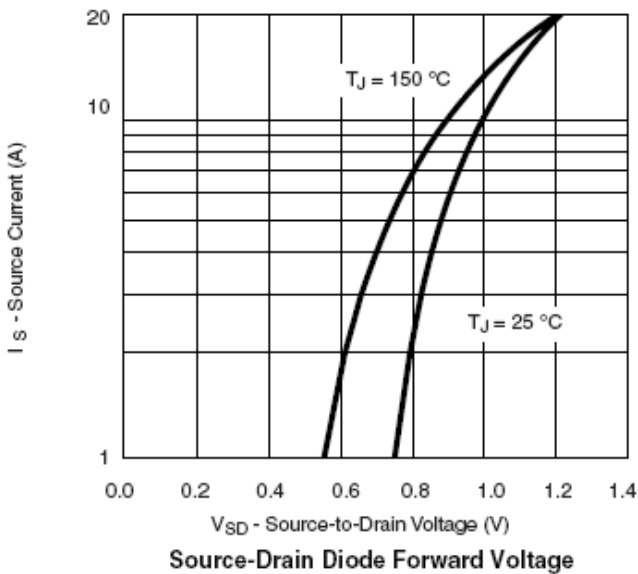
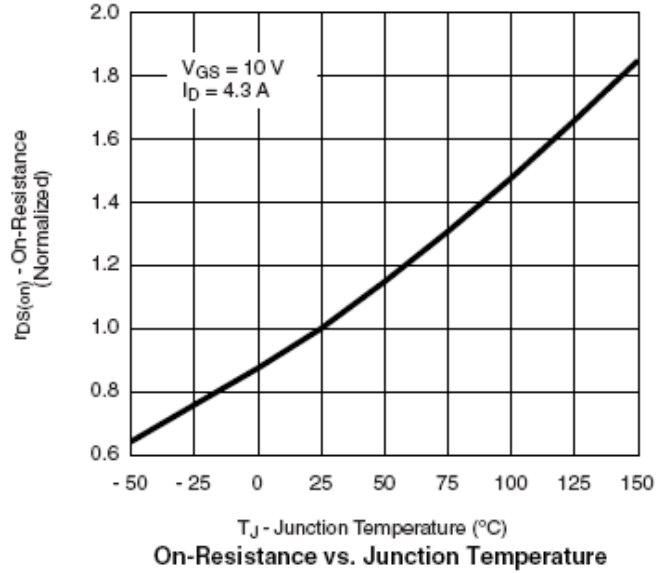
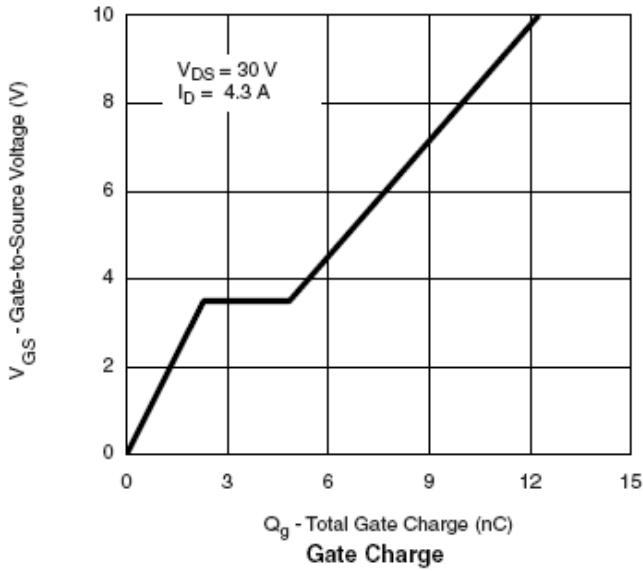




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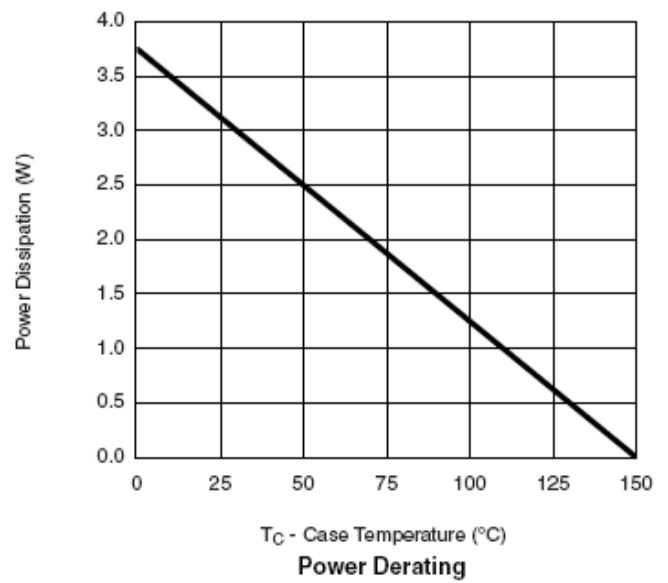
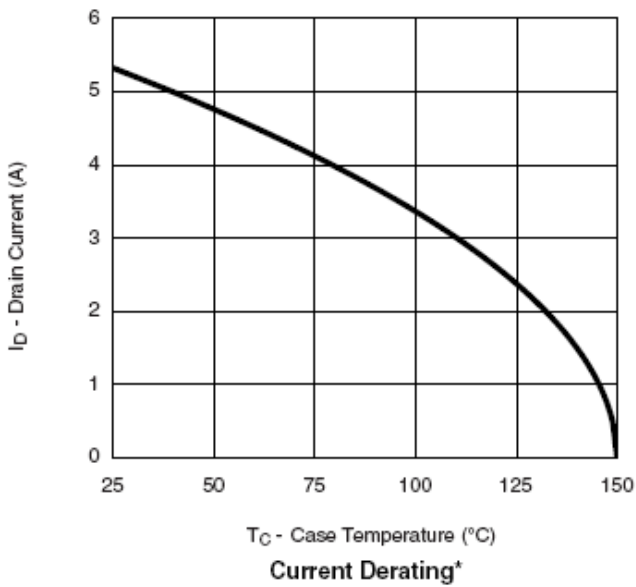
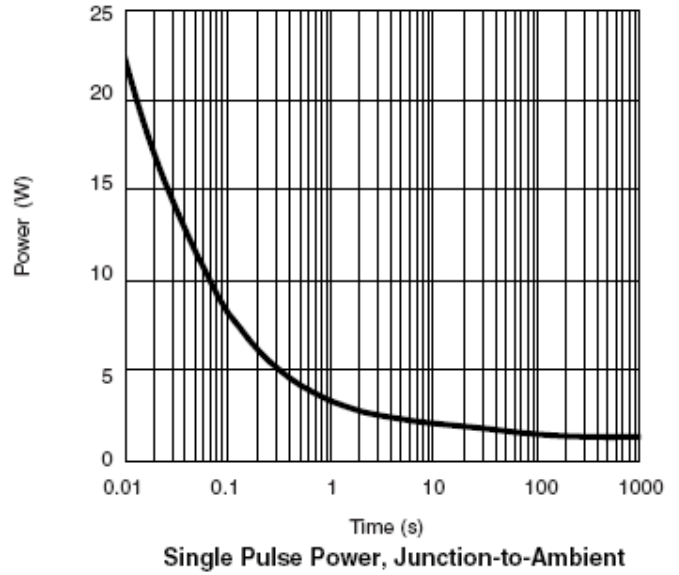
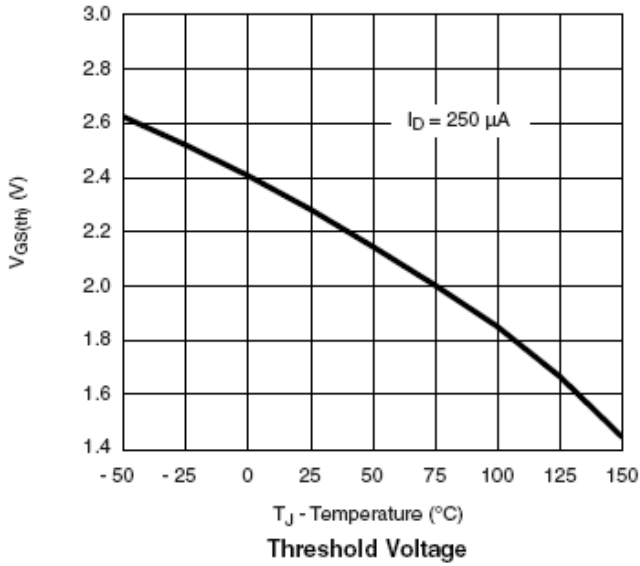




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### TYPICAL CHARACTERISTICS







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